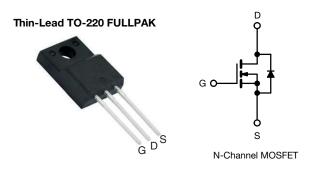
SiHA100N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.086			
Q _g max. (nC)	50				
Q _{gs} (nC)	13				
Q _{gd} (nC)	10				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA100N60E-GE3				

ABSOLUTE MAXIMUM RATINGS (T _C	20 0, 0					
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	- V	
Gate-source voltage			V _{GS}	± 30		
Continuous drain current (T _J = 150 °C) e	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1-	12		
Continuous drain current $(1) = 130^{\circ}$ C)	V _{GS} at 10 V	T _C = 100 °C	I _D	8	А	
Pulsed drain current ^a	I _{DM}	73	1			
Linear derating factor		0.28	W/°C			
Single pulse avalanche energy ^b			E _{AS}	226	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			al (alt	100	V/ns	
Reverse diode dv/dt ^d			dv/dt	23		
Soldering recommendations (peak temperature) ^c For 10 s				260	°C	
Mounting torgue, M3 screw				0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.0 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

S21-0257-Rev. C, 22-Mar-2021

1 For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN

FREE



THERMAL RESISTANCE RA	TINGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum junction-to-ambient	R _{thJA}	-		°C/W				
Maximum junction-to-case (drain)	R _{thJC}	-						
SPECIFICATIONS (T_J = 25 $^\circ\text{C}$, unless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CC	NDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					-			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.73	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		3.0	-	5.0	V	
Onto any inclusion		V _{GS} = ± 20 V		-	-	± 100	nA	
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 30 V$ -	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA	
7		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1		
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 13 A		-	0.086	0.1	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} = 8 V, I _D = 13 A		-	11	-	S	
Dynamic	•	•		•				
Input consoitance					1051		T	

-							
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	1851	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$		-	84	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	64	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	407	-	
Total gate charge	Qg			-	33	50	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$	-	13	-	nC
Gate-drain charge	Q _{gd}			-	10	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 13 A, V _{GS} = 10 V, R _g = 9.1 Ω f = 1 MHz, open drain		-	21	42	ns
Rise time	t _r			-	34	68	
Turn-off delay time	t _{d(off)}			-	33	66	
Fall time	t _f			-	20	40	
Gate input resistance	R _g			0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	30	А
Pulsed diode forward current	I _{SM}			-	-	73	~
Diode forward voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 13 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 13 A, di/dt = 100 A/µs, V _R = 25 V		-	358	716	ns
Reverse recovery charge	Q _{rr}			-	5.1	10.2	μC
Reverse recovery current	I _{RRM}			-	24	-	А

Notes

f. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} g. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

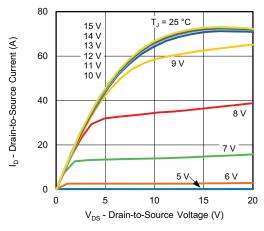


Fig. 1 - Typical Output Characteristics

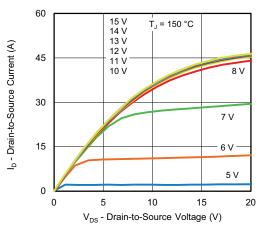


Fig. 2 - Typical Output Characteristics

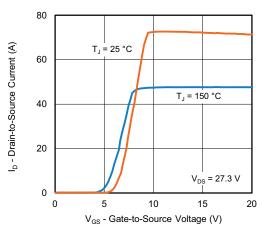


Fig. 3 - Typical Transfer Characteristics

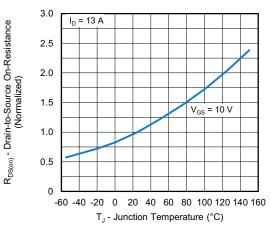


Fig. 4 - Normalized On-Resistance vs. Temperature

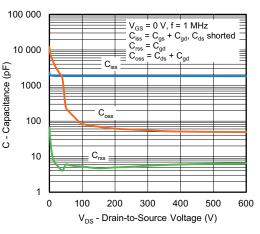
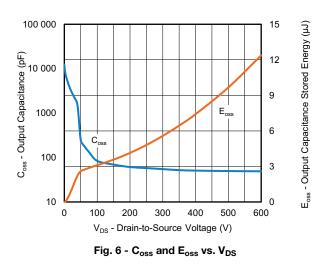


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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SiHA100N60E

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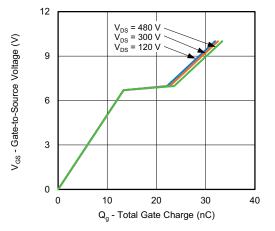


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

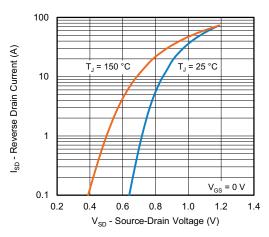


Fig. 8 - Typical Source-Drain Diode Forward Voltage

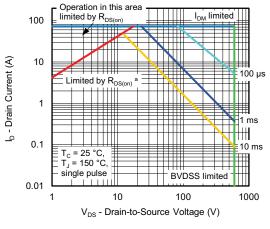
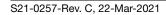


Fig. 9 - Maximum Safe Operating Area

Note

h. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



4

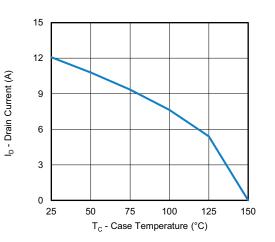


Fig. 10 - Maximum Drain Current vs. Case Temperature

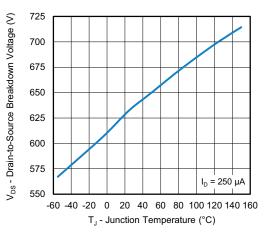
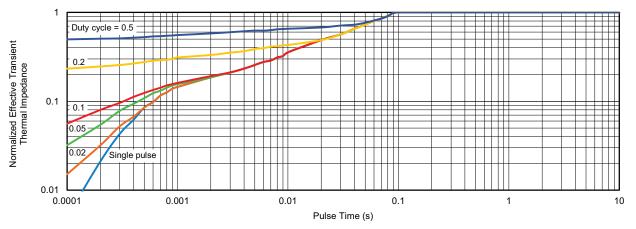
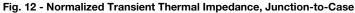


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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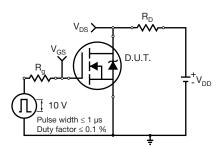


Fig. 13 - Switching Time Test Circuit

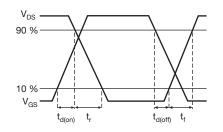


Fig. 14 - Switching Time Waveforms

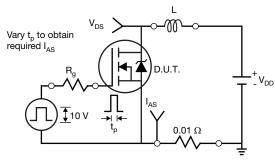


Fig. 15 - Unclamped Inductive Test Circuit

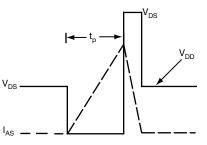


Fig. 16 - Unclamped Inductive Waveforms

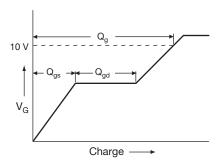
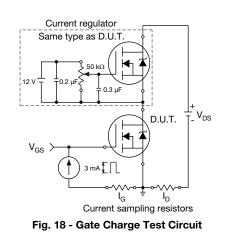


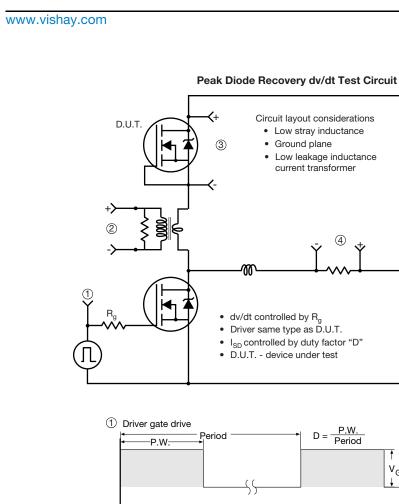
Fig. 17 - Basic Gate Charge Waveform



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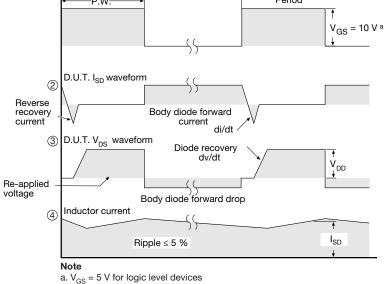


Fig. 19 - For N-Channel

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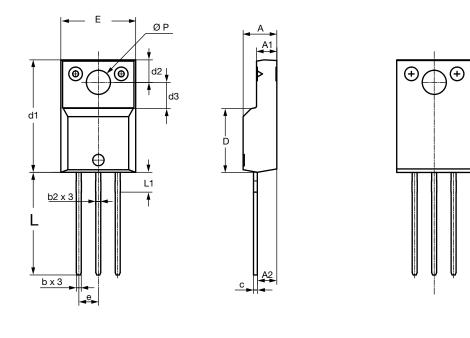
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SiHA100N60E **Vishay Siliconix**

V_{DD}



TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•		

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